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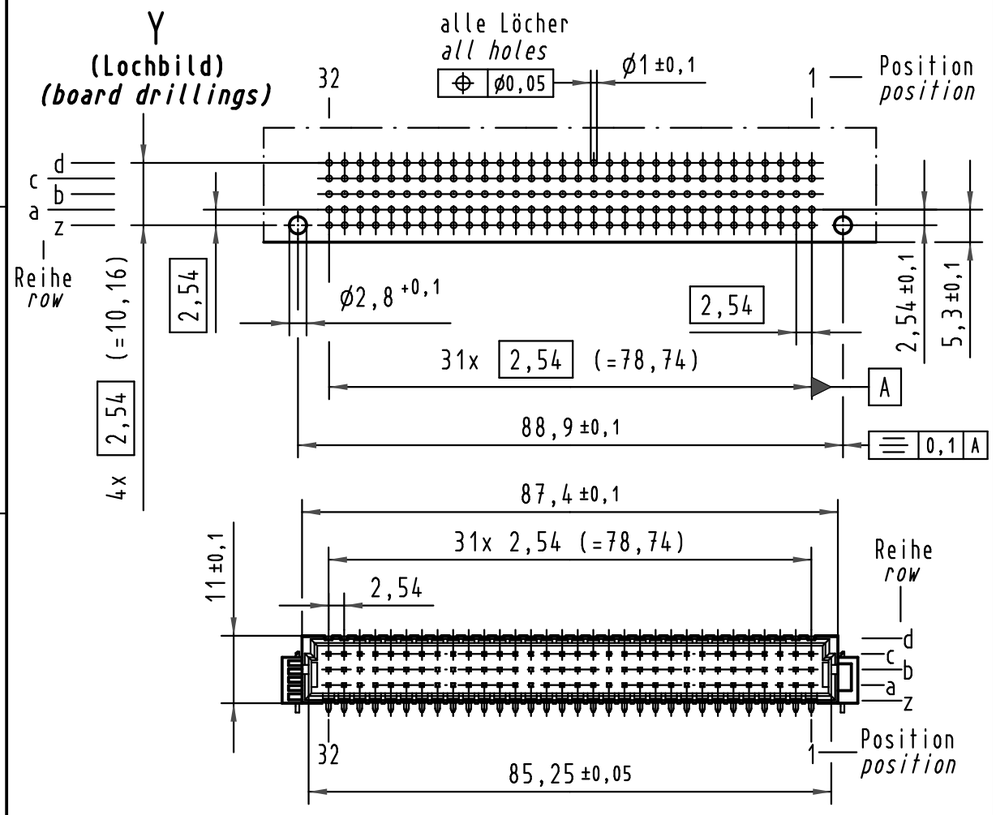
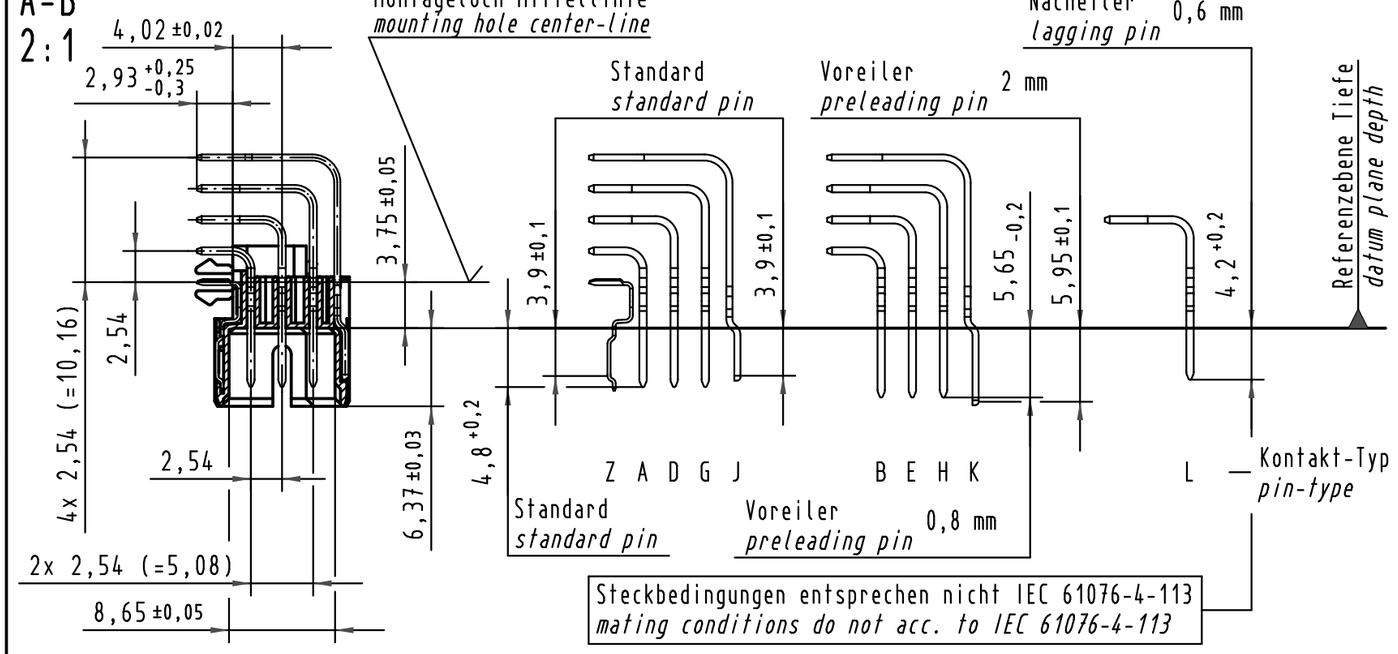
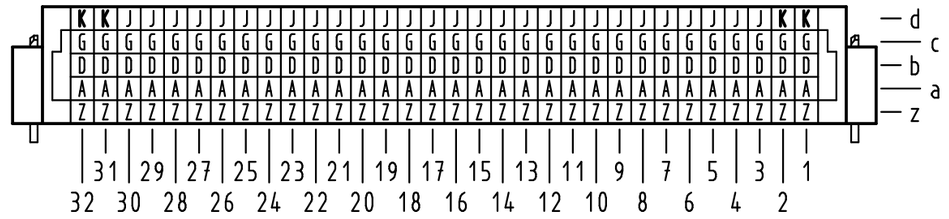
Y
(Lochbild)
(board drillings)

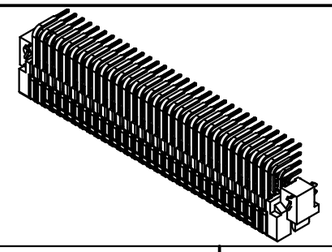


A-B
2:1



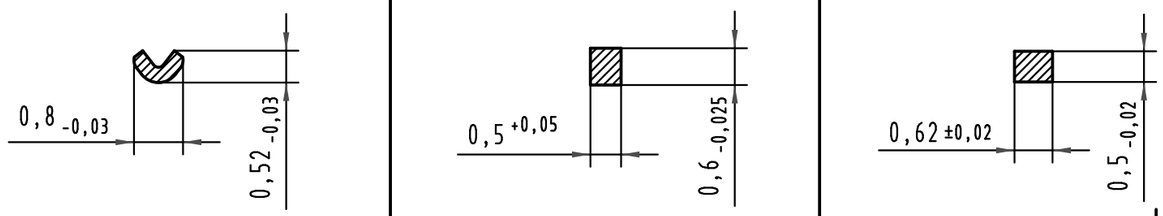
X
Kontaktbelegung
contact loading





Z
10:1

Querschnitt der Lötanschlüsse:
cross-section of solder terminations:



02 01 160 3102	3	Au über/over Ni	Au flash over PdNi over Ni
02 01 160 2102	2	Au über/over Ni	Au flash over PdNi over Ni
02 01 160 1102	1	Au über/over Ni	Au flash over PdNi over Ni
Bestell-Nr. *part-no.*	Anforderungsstufe nach IEC *performance level acc.to IEC*	Reihe / *row* z + d Kontaktoberfläche / *contact plating*	Reihe / *row* a + b + c Kontaktoberfläche / *contact plating*

All Dimensions in mm
Original Size DIN A 3

Techn. Character.

Nicht tolerierte Maße/ *Free size tolerances*
IEC 61076-4-113

35551	10.08.09	Hage.
33075	05.10.05	Leh.
32687	26.04.05	Hage.
32460	25.01.05	Leh.
31412	09.04.03	Hage.
30920	10.04.02	Rie.
Mod.	Dat.	Name

	Dat.	Name
Detail.	09.10.96	Rie.
Insp.	09.10.96	Pa.
Stand.		

Maßstab/*Scale* 1:1 (2:1) (10:19

har-bus 64 male connector

Einlöt 160 pol. SMC (Hochtemperatur) mit Clip
solder 160 pol. SMC (high temperature) with clip

HARTING Electronics GmbH & Co. KG
D-32339 ESPELKAMP

TB 02 01 160 x102

Blatt/ *page*

Sub.